

## 12-Channel High Voltage Analog Switch

### Ordering Information

$V_{PP} - V_{NN}$	Package Options	
	48-pin TQFP	Die
200V	HV209FG	HV209X

### Features

- HVCMOS technology for high performance
- Operating voltage of up to 200V
- Output On-resistance typically  $22\Omega$
- Integrated bleed resistors on the outputs
- Very low quiescent power dissipation  $-10\mu A$
- Low parasitic capacitances
- $-58dB$  typical output off isolation at 5MHz
- 5.0V to 12V CMOS logic circuitry
- Excellent noise immunity
- Flexible high voltage supplies

### General Description

The Supertex HV209 is a 200V low charge injection 12-channel high voltage analog switch configured as 6 SPDT analog switch intended for medical ultrasound applications. Bleed resistors are integrated on the output switches to eliminate charge built up on the piezo electric transducers. The bleed resistors are at a nominal value of  $35K\Omega$ . Using HVCMOS technology, this device combines high voltage bilateral DMOS switches and low power CMOS logic to provide efficient control of high voltage analog signals. The outputs are configured as single pole double throw analog switches. Data is shifted into a 6-bit shift register using an external clock. The LE latches the shift register data into the individual switch latches. A logic high connects a switch common  $Y_X$  to  $SW_X$ . A logic low connects  $Y_X$  to  $SW_X$ . A logic hi in CL resets all switches to  $SW_X$  simultaneously.

### Absolute Maximum Ratings\*

$V_{DD}$ Logic power supply voltage	-0.5V to +15V
$V_{PP} - V_{NN}$ Supply voltage	+220V
$V_{PP}$ Positive high voltage supply	-0.5V to +200V
$V_{NN}$ Negative high voltage supply	+0.5V to -200V
Logic input voltages	-0.5V to $V_{DD}$ +0.3V
$V_{SIG}$ Analog Signal Range	$V_{NN}$ to $V_{PP}$
Peak analog signal current/channel	3.0A
Storage temperature	-65°C to +150°C
Power dissipation	1.0W

\* All voltages are referenced to ground. Absolute maximum ratings are those values which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability.

# Electrical Characteristics

**DC Characteristics** (over recommended operating conditions unless otherwise noted)

Characteristics	Sym	0°C		+25°C			+70°C		Units	Test Conditions		
		min	max	min	typ	max	min	max		I <sub>SIG</sub> = 5mA	V <sub>PP</sub> = 40V, V <sub>NN</sub> = -160V	
Small Signal Switch (ON) Resistance	R <sub>ONS</sub>		30		26	38		48	ohms	I <sub>SIG</sub> = 200mA	V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V	
			25		22	27		32		I <sub>SIG</sub> = 200mA	V <sub>PP</sub> = 190V, V <sub>NN</sub> = -10V	
			25		22	27		30		I <sub>SIG</sub> = 5mA	V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V	
			18		18	24		27		I <sub>SIG</sub> = 200mA	V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V	
			23		20	25		30		I <sub>SIG</sub> = 5mA	V <sub>PP</sub> = 190V, V <sub>NN</sub> = -10V	
			22		16	25		27		I <sub>SIG</sub> = 200mA	V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V	
Small Signal Switch (ON) Resistance Matching	ΔR <sub>ONS</sub>		20		5.0	20		20	%	I <sub>SW</sub> = 5mA, V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V		
Large Signal Switch (ON) Resistance	R <sub>ONL</sub>				15				ohms	V <sub>SIG</sub> = V <sub>PP</sub> - 10V, I <sub>SIG</sub> = 1A		
Output Switch Shunt Resistance	R <sub>INT</sub>			20	35	50			Kohms	Output switch to R <sub>GND</sub>		
DC Offset Switch Off			50			50		50	mV	No Load, R <sub>GND</sub> = 0V		
DC Offset Switch On			50			50		50	mV	No Load, R <sub>GND</sub> = 0V		
Pos. HV Supply Current	I <sub>PPQ</sub>			10	50				μA	ALL SWs OFF		
Neg. HV Supply Current	I <sub>NNQ</sub>			-10	-50				μA	ALL SWs OFF		
Pos. HV Supply Current	I <sub>PPQ</sub>			10	50				μA	ALL SWs ON I <sub>SW</sub> = 5mA		
Neg. HV Supply Current	I <sub>NNQ</sub>			-10	-50				μA	ALL SWs ON I <sub>SW</sub> = 5mA		
Switch Output Peak Current			3.0		3.0	2.0		2.0	A	V <sub>SIG</sub> duty cycle ≤ 0.1%		
Output Switch Frequency	f <sub>SW</sub>					50			KHz	Duty Cycle = 50%		
I <sub>PP</sub> Supply Current	I <sub>PP</sub>		6.5			7.0		8.0	mA	V <sub>PP</sub> = 40V, V <sub>NN</sub> = -160V	50KHz Output Switching Frequency with no load	
			4.0			5.0		5.5		V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V		
			4.0			5.0		5.5		V <sub>PP</sub> = 190V, V <sub>NN</sub> = -10V		
I <sub>NN</sub> Supply Current	I <sub>NN</sub>		6.5			7.0		8.0	mA	V <sub>PP</sub> = 40V, V <sub>NN</sub> = -160V		
			4.0			5.0		5.5		V <sub>PP</sub> = 100V, V <sub>NN</sub> = -100V		
			4.0			5.0		5.5		V <sub>PP</sub> = 190V, V <sub>NN</sub> = -10V		
Logic Supply Average Current	I <sub>DD</sub>		4.0			4.0		4.0	mA	f <sub>CLK</sub> = 5MHz, V <sub>DD</sub> = 5.0V		
Logic Supply Quiescent Current	I <sub>DDQ</sub>		10			10		10	μA			
Data Out Source Current	I <sub>SOR</sub>	0.45		0.45	0.70		0.40		mA	V <sub>OUT</sub> = V <sub>DD</sub> - 0.7V		
Data Out Sink Current	I <sub>SINK</sub>	0.45		0.45	0.70		0.40		mA	V <sub>OUT</sub> = 0.7V		
Logic Input Capacitance	C <sub>IN</sub>		10			10		10	pF			

# Electrical Characteristics

**AC Characteristics** (over operating conditions  $V_{DD} = 5V$ , unless otherwise noted)

Characteristics	Sym	0°C		+25°C			+70°C		Units	Test Conditions
		min	max	min	typ	max	min	max		
Set Up Time Before LE Rises	$t_{SD}$	150		150			150		ns	
Time Width of LE	$t_{WLE}$	150		150			150		ns	
Clock Delay Time to Data Out	$t_{DO}$		150			150		150	ns	
Time Width of CL	$t_{WCL}$	150		150			150		ns	
Set Up Time Data to Clock	$t_{SU}$	15		15	8.0		20		ns	
Hold Time Data from Clock	$t_h$	35		35			35		ns	
Clock Freq	$f_{CLK}$		5.0			5.0		5.0	MHz	50% duty cycle $f_{DATA} = f_{CLK}/2$
Turn On Time	$t_{ON}$		5.0			5.0		5.0	μs	$V_{SIG} = V_{PP} - 10V$ , $R_L = 10K\Omega$
Turn Off Time	$t_{OFF}$		5.0			5.0		5.0	μs	$V_{SIG} = V_{PP} - 10V$ , $R_L = 10K\Omega$
Maximum $V_{SIG}$ Slew Rate	dv/dt		20			20		20	V/ns	$V_{PP} = 40V$ , $V_{NN} = -160V$
			20			20		20		$V_{PP} = 100V$ , $V_{NN} = -100V$
			20			20		20		$V_{PP} = 190V$ , $V_{NN} = -10V$
Off Isolation	KO	-30		-30	-33		-30		dB	$f = 5MHz$ , $1K\Omega/15pF$ load
		-58		-58			-58		dB	$f = 5MHz$ , $50\Omega$ load
Switch Crosstalk	$K_{CR}$	-60		-60	-70		-60		dB	$f = 5MHz$ , $50\Omega$ load
Output Switch Isolation Diode Current	$I_{ID}$		300			300		300	mA	300ns pulse width, 2.0% duty cycle
Off Capacitance SW to GND	$C_{SG(OFF)}$	5.0	17	5.0	12	17	5.0	17	pF	0V, 1MHz
On Capacitance SW to GND	$C_{SG(ON)}$	25	50	25	38	50	25	50	pF	0V, 1MHz
Positive Output Voltage Spike	$+V_{SPK}$		150			150		150	mV	$R_{LOAD} = 50\Omega$
Negative Output Voltage Spike	$-V_{SPK}$		150			150		150	mV	$R_{LOAD} = 50\Omega$

# Operating Conditions\*

Symbol	Parameter	Value
$V_{PP}$	Positive high voltage supply <sup>1</sup>	+40V to $V_{NN} + 200V$
$V_{NN}$	Negative high voltage supply <sup>1</sup>	-10V to -160V
$V_{DD}$	Logic power supply voltage <sup>1</sup>	+4.5V to +13.2V
$V_{IH}$	High-level input voltage	0.8 $V_{DD}$ to $V_{DD}$
$V_{IL}$	Low-level input voltage	0V to 0.2 $V_{DD}$
$V_{SIG}$	Analog signal voltage peak-to-peak <sup>2</sup>	$V_{NN} + 10V$ to $V_{PP} - 10V$
$T_A$	Operating free air-temperature	0°C to 70°C

**Notes:**

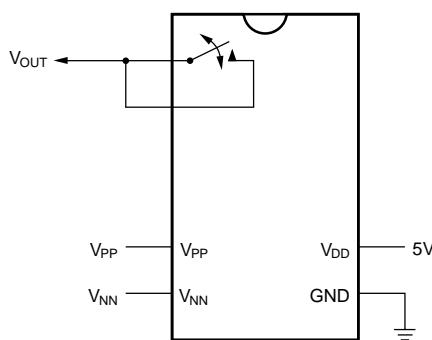
1 Power up/down sequence is arbitrary except GND must be powered-up first and powered-down last.

2  $V_{SIG}$  must be within  $V_{PP}$  and  $V_{NN}$  voltage range or floating during power up/down transition.

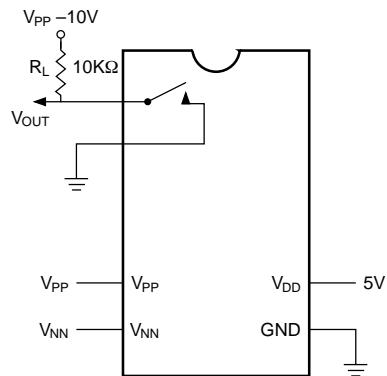
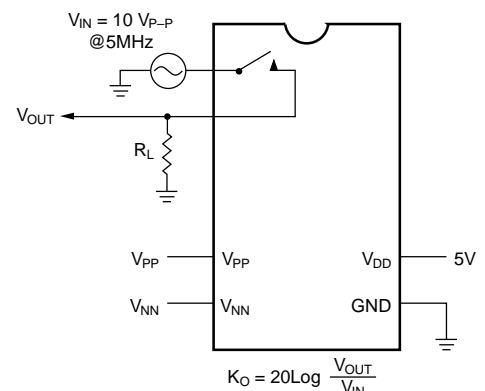
## Truth Table

Data Inputs						$\overline{LE}$	CL	Switch States					
DO	D1	D2	D3	D4	D5			Y0	Y1	Y2	Y3	Y4	Y5
L						L	L	<u>SW0</u>					
H						L	L	SW0					
	L					L	L		<u>SW1</u>				
	H					L	L		SW1				
		L				L	L			<u>SW2</u>			
		H				L	L			SW2			
			L			L	L				<u>SW3</u>		
			H			L	L				SW3		
				L		L	L					<u>SW4</u>	
				H		L	L					SW4	
					L	L	L						<u>SW5</u>
					H	L	L						SW5
X	X	X	X	X	X	H	L	HOLDS PREVIOUS STATE					
X	X	X	X	X	X	X	H	SW0	SW1	SW2	SW3	SW4	SW5

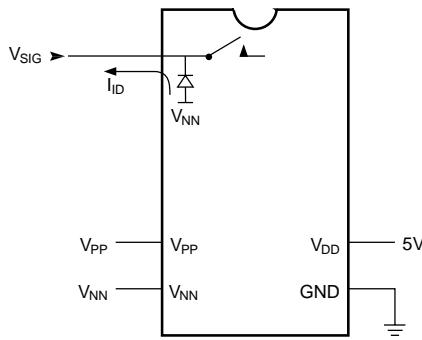
# Test Circuits



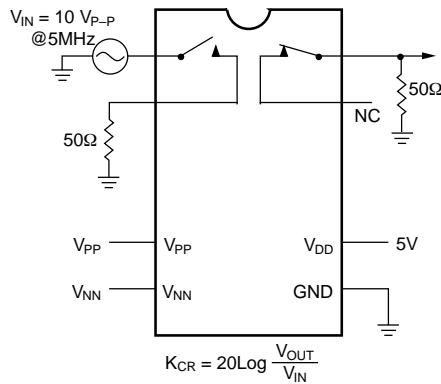
DC Offset ON/OFF

 $T_{ON}/T_{OFF}$  Test Circuit

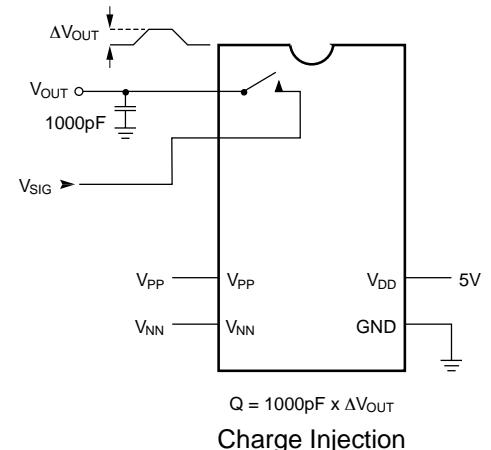
OFF Isolation



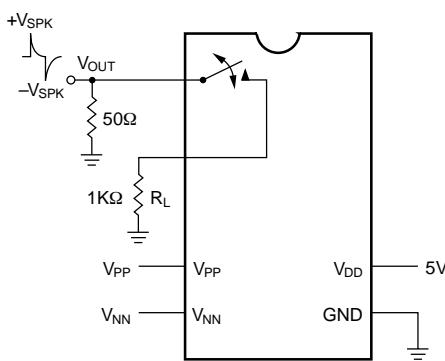
Isolation Diode Current



Crosstalk

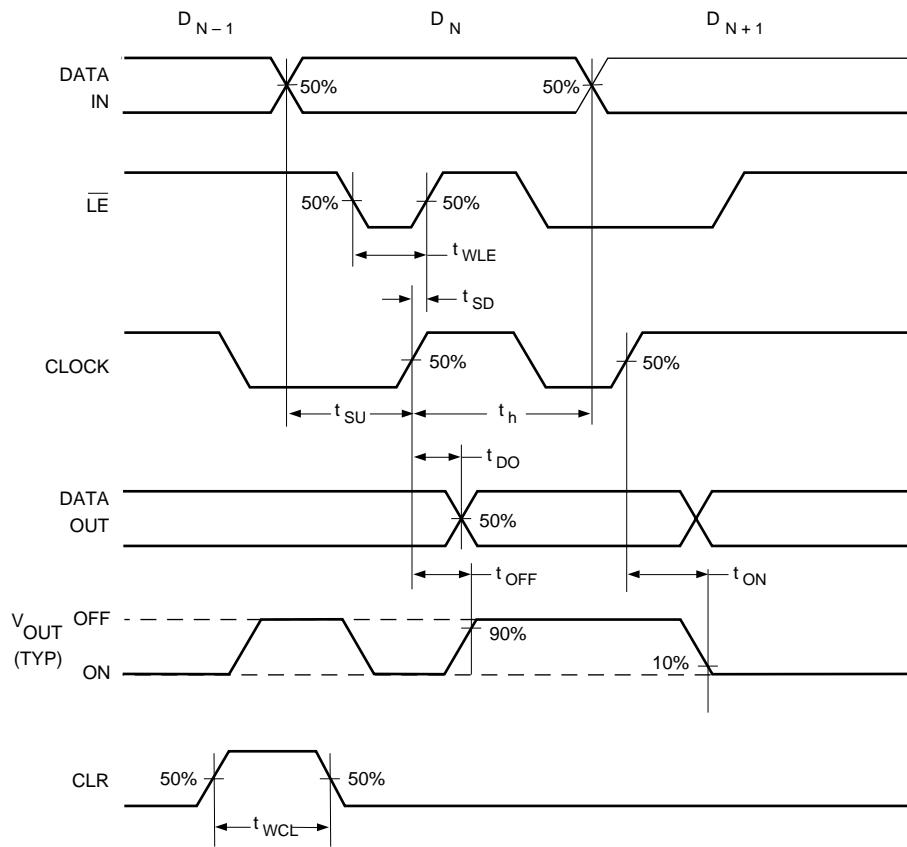


Charge Injection

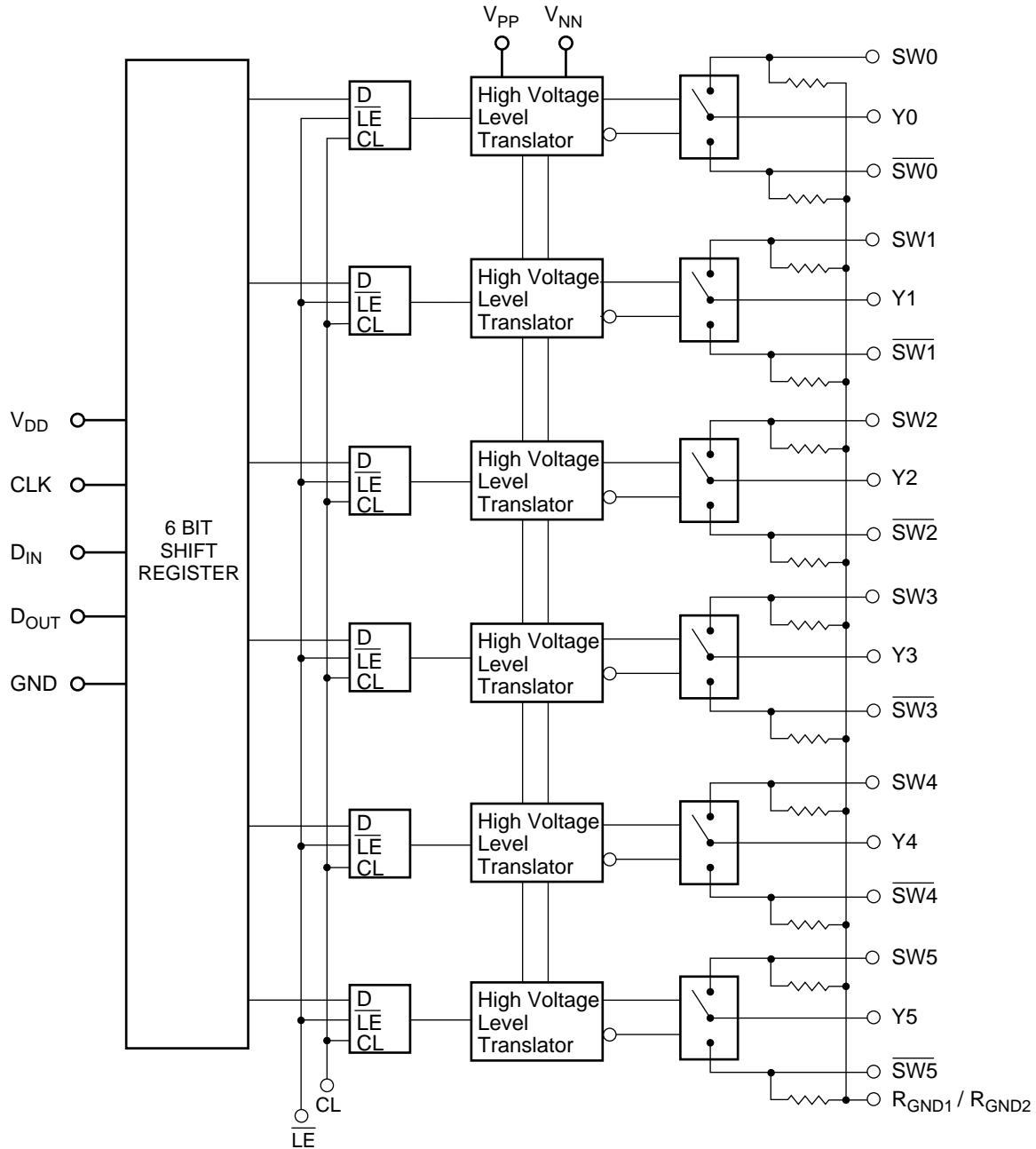


Output Voltage Spike

# Logic Timing Waveforms



# Block Diagram



# Pin Configuration

HV209 48-Pin TQFP

Pin	Function	Pin	Function
1	N/C	25	SW5
2	SW0	26	Y5
3	Y0	27	SW5
4	<u>SW0</u>	28	N/C
5	N/C	29	SW3
6	SW2	30	Y3
7	Y2	31	SW3
8	<u>SW2</u>	32	N/C
9	N/C	33	<u>SW1</u>
10	SW4	34	Y1
11	Y4	35	SW1
12	<u>SW4</u>	36	N/C
13	N/C	37	$R_{GND1}$
14	N/C	38	N/C
15	N/C	39	$D_{OUT}$
16	$V_{NN}$	40	$V_{DD}$
17	N/C	41	$D_{IN}$
18	N/C	42	CLR
19	N/C	43	LE
20	N/C	44	CLK
21	$V_{PP}$	45	GND
22	N/C	46	N/C
23	N/C	47	N/C
24	N/C	48	$R_{GND2}$

# Package Outline

